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| <b>Notice of References Cited</b> | Application/Control No.<br>10/811,222 |  | Applicant(s)/Patent Under<br>Reexamination<br>CHAO ET AL. |             |
|                                   | Examiner<br>TIPHANY B. DICKERSON      |  | Art Unit<br>3623  | Page 1 of 1 |

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|   | F | US-  |                 |             |                |
|   | G | US-  |                 |             |                |
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|   | M | US-  |                 |             |                |

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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
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